



Cold Plasma Technology as an Alternative to Vapor Degreasing

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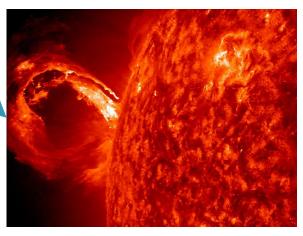


What exactly is Cold Plasma?

• Plasma is ionized gas, a state of matter made of electrically charged particles.

This is hot (or thermal) plasma

High pressure and temperature





This is cold (or atmospheric) plasma

Atmosphere pressure (or vacuum) and moderated temperatures

- •Cold plasma is generated by an oscillating electric field (microwaves or radiofrequency) to ionize gas molecules.
- •Some applications for (low intensity) cold plasma:

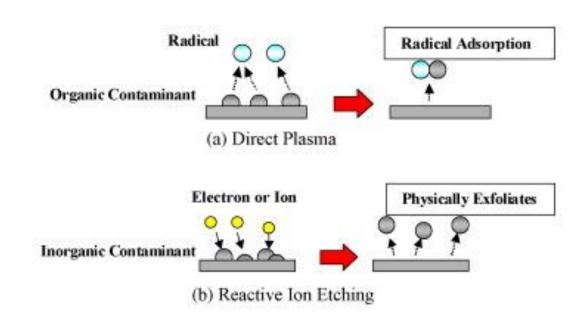
Surface cleaning: removes oil, grease, and bacteria.

- Plasma etching: coating metals with a controlled layer of oxide.
- *Plasma deposition:* deposit materials onto metallic, plastic or ceramic surfaces.
- Biomedicine: R&D for use in wound healing, beauty and cancer treatment.



Cold plasma mode of action

- The charged particles present in the plasma adsorb and react with any loose soil.
- Low intensity cold plasma can clean surfaces in atmospheric conditions at low temperatures without requiring solvent use*.
- Since atmospheric plasma operates at nearambient temperatures, it can be applied to heat-sensitive materials.
- Moreover, the technology is readily available on the market for the electronic, metalworking, and plating industries.



* Nakamura et al. (2009) https://doi.org/10.1016/j.apsusc.2009.05.121



Two modes of operation: Direct and indirect

Plasma Chamber



Small parts.

Batch operation.

Easy VOC emission control.

Vacuum + Plasma -> Cleaning

The **direct** mode of operation is achieved by placing the substrate between the electrodes, usually in reduced-pressure chambers.

Indirect plasma (also called *post-discharge*) is propelled through a tip where the plasma contacts the substrate surface in the form of a jet.

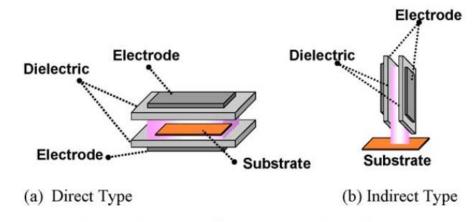


Fig. 4. Reactor form. (a) Direct type and (b) indirect type.

Plasma Jet



Large parts.

Batch or continuous mode.

Automated setting.

Jet impact + Plasma -> cleaning

* Nakamura et al. (2009) https://doi.org/10.1016/j.apsusc.2009.05.121

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Plasma Jet in action

Images and videos from Plasmatreat visit to TURI (Dec. 2022)

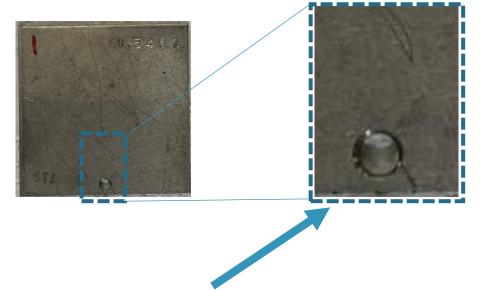


Contaminate: Cutting Oil

Substrate: Nickel Plated Copper

Cleaning agent: Plasmatreat Rotating Jet RD1004HVC; standard jet nozzle; 10 mm depth





Treated sample: Wettability as new (visual drop test), 95%+ oil removal in seconds



Plasma Jet in action

Images and videos from Plasmatreat visit to TURI (Dec. 2022)



Contaminate: Paint

Substrate: Stainless steel cutting tool part

Cleaning agent: Plasmatreat Rotating Jet RD1004HVC; standard jet nozzle; 5 mm depth

Removal time: 2-3 seconds on the spot, quick and easy (vs. immersion and scrubbing with TCE).



Optimization variables:

- Residence time over cleaning spot.
- Nozzle surface distance.
- Carrier gas (air, oxygen, ...)



Cold Plasma Technology as an alternative to vapor degreasing for parts cleaning.

Open top	Classic enclosed	Airless enclosed
Cheapest option (150 – 300 USD) Highest solvent exposure Low solvent use efficiency No fire protection	Moderate CapEx (10K – 40K USD) Some control of solvent exposure Moderate solvent use efficiency Weak fire protection	High CapEx (300K – 500K USD) Lowest solvent exposure Solvent recycling capacity (one charge lasts years) Can use flammable solvents (in proper building)



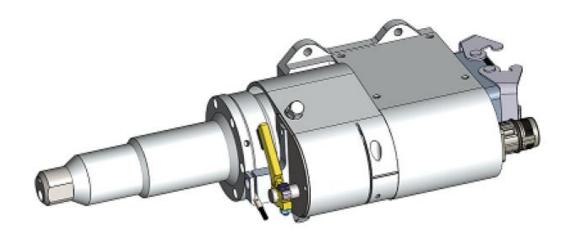




Cold Plasma Technology as an alternative to vapor degreasing for parts cleaning.

Plasma Chamber	Plasma Jet	
Low CapEx (10K USD / unit)	Moderated CapEx (about 70K USD / unit)	
No solvent use	No solvent use	
Ideal for small parts	Ideal for big parts in automated setting	
Batch mode	Continuous production, high throughput	







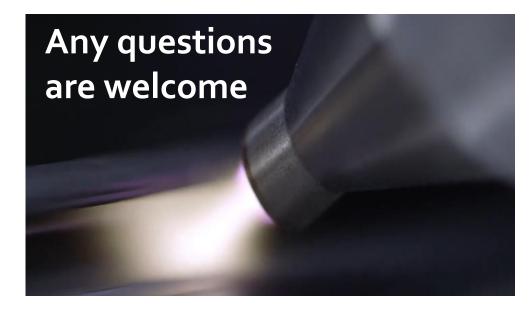
Comparative SWOT analysis

Technology	Classic vapor degreasing	Airless vapor degreasing	Plasma chamber	Plasma Jet
Strength	Low CapEx.Known technology.	 High solvent use efficiency. Solvent recycling. Elimination of workers' exposure to solvent. 	 Solventless alternative. Ideal for small parts. Easy VOC emission control. 	 Solventless alternative. Faster paint removal than solvents.
Weakness	 Works with non- flammable, mostly halogenated, solvents. TURA, HazMat and disposal fees. 	 Exceedingly high investment. Very low ROI. 	 Not scalable to medium to large surfaces. Batch processing. Hard to reach complex shape features (blind holes, grooves, etc.). 	 Additional investment in routing or robotic arms for its operation. Complex parts can be tricky.
Opportunities	 Improving solvent use efficiency. Safer solvents may (or may not) be available. 	 TURA fee savings Eliminating TCE use could attract external funding. 	 TURA fee savings Hazmat fee savings. Low investment. Large ROI. 	TURA fee savings.HazMat fee savings.Moderate investment.Large ROI.
Threats	 Halogenated solvents are toxic to workers and the environment. 	 Greener solvent alternatives are flammable. 	Several units might be required.Requires VOC filtering.	Several units might be required.Requires VOC control.



Work in the near future

- Development of a systematic methodology to evaluate the cleaning efficacy of cold plasma on industrially relevant surfaces stained with various soils.
- Compare cleaning performances between plasma jet and plasma chamber.
- Compare the degreasing performance with halogenated solvents: perchloroethylene (PCE), trans-dichloroethylene (tDCE), n-propyl bromide (nPB), etc.
- Feasibility analysis of cold plasma technology in diverse scenarios.
- Assess the feasibility of plasma activated water for disinfection.



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